DESCRIPTION: 0.085 RIBBON - SOLDER CUP

DIMENSIONS(mm)								
SIZE	A	B±0.25	C±0.25					
14	43.90±0.30	25.50	36.00					
24	54.70±0.30	36.30	46.80					
36	67.75±0.30	49.00	59.74					
50	82.85±0.30	64.47	74.85					

SPECIFICATIONS:

ELECTRICAL:

MATERIALS: INSULATION:

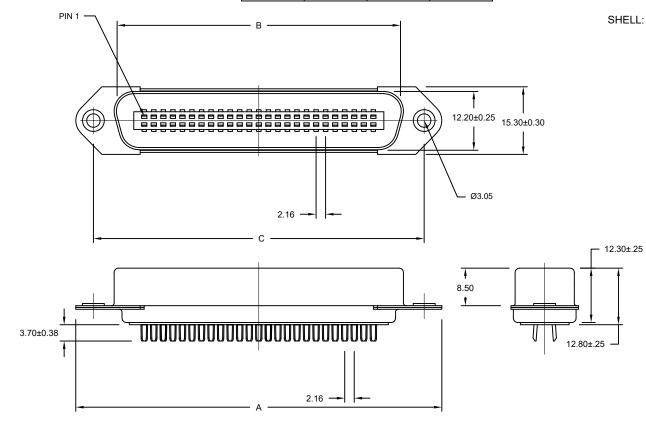
CONTACTS:

CONTACT PLATING:

CURRENT RATING::INSULATION RESISTANCE::DIELECTRIC WITHSTANDING VOLTAGE::CONTACT RESISTANCE::OPERATING TEMPERATURE::

1 AMPS 1,000 MΩ MIN. @ 500 VDC 1,000 VAC FOR 1 MINUTE 30 mΩ MAX. -55°C TO +105°C

PBT, UL 94 V-O RATED PHOSPHOR BRONZE GOLD FLASH IN MATING AREA BRIGHT TIN IN SOLDER AREA STEEL, NICKEL PLATED



<u>111-YYY-1 0 3 L 00 1</u> SERIES POSITIONS 014 024 036 050 GENDER 1 = MALETERMINATION 0 = SOLDER CUP SHELL PLATING 3 = NICKEL **RoHS COMPLIANT-**L = LOW TEMP. PROCESS HARDWARE 00 = NO HARDWARE PLATING -1 = GOLD FLASH

WILL ACCEPT 26-20 AWG WIRE

RoHS C	OMPLIANT		_	UNITS = mm) NOT SC/	ale from draw	ING
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		DATE: 01/16/2019		INDICOMP	DWG NO. 111-YYY-103L00		

